General Information of IJCMDI

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Journal Aims

Our Journal provides a chance for academic and industry professionals to discuss recent progress in the area of computer-aided mechanical design and implementation.

To bridge the gap of users who do not have access to major databases where one should pay for every downloaded article; this online publication platform is open to all readers as part of our commitment to global scientific society.

Journal Topics

The main topics include but will not be limited to: (Excellent surveying works, summary or introduction of new or fresh idea in these areas are welcome, too).

- Advanced CAE Technique
- Complex Electro-mechanical System Design
- Computer Aided Design, Product Design
- Design for Manufacturing, Axiomatic Design
- Design for Sustainability
- Design theory and Applications
- Driven Train Mechanisms
- Green Design and Manufacturing
- Innovative Design Methodology
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- Machinery Dynamics
- Optimization of Design
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